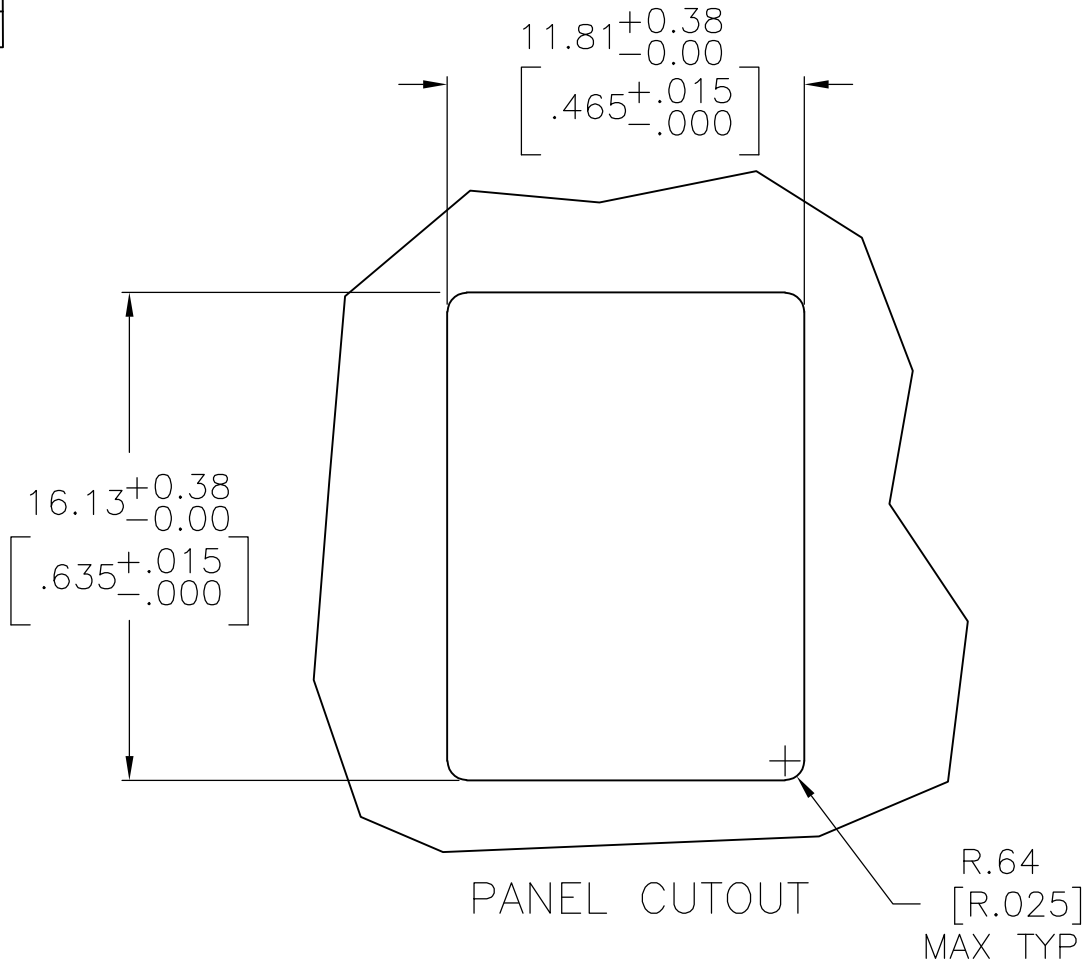
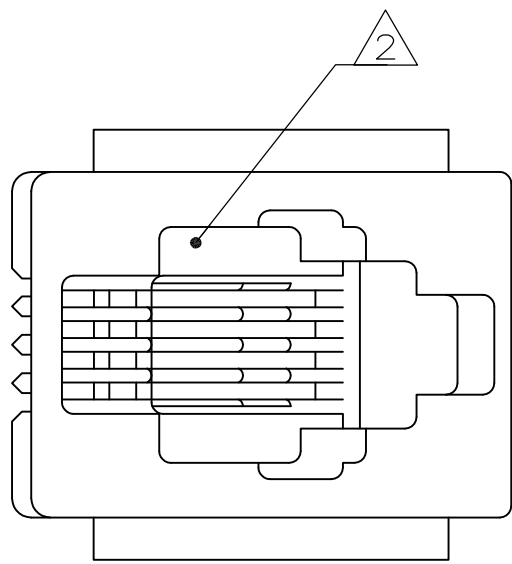


LOC	DIST	REVISIONS					
		P	LTR	DESCRIPTION	DATE	DWN	APVD
AA	00		B	ECO-07-017784	14AUG07	LAM	PR

D

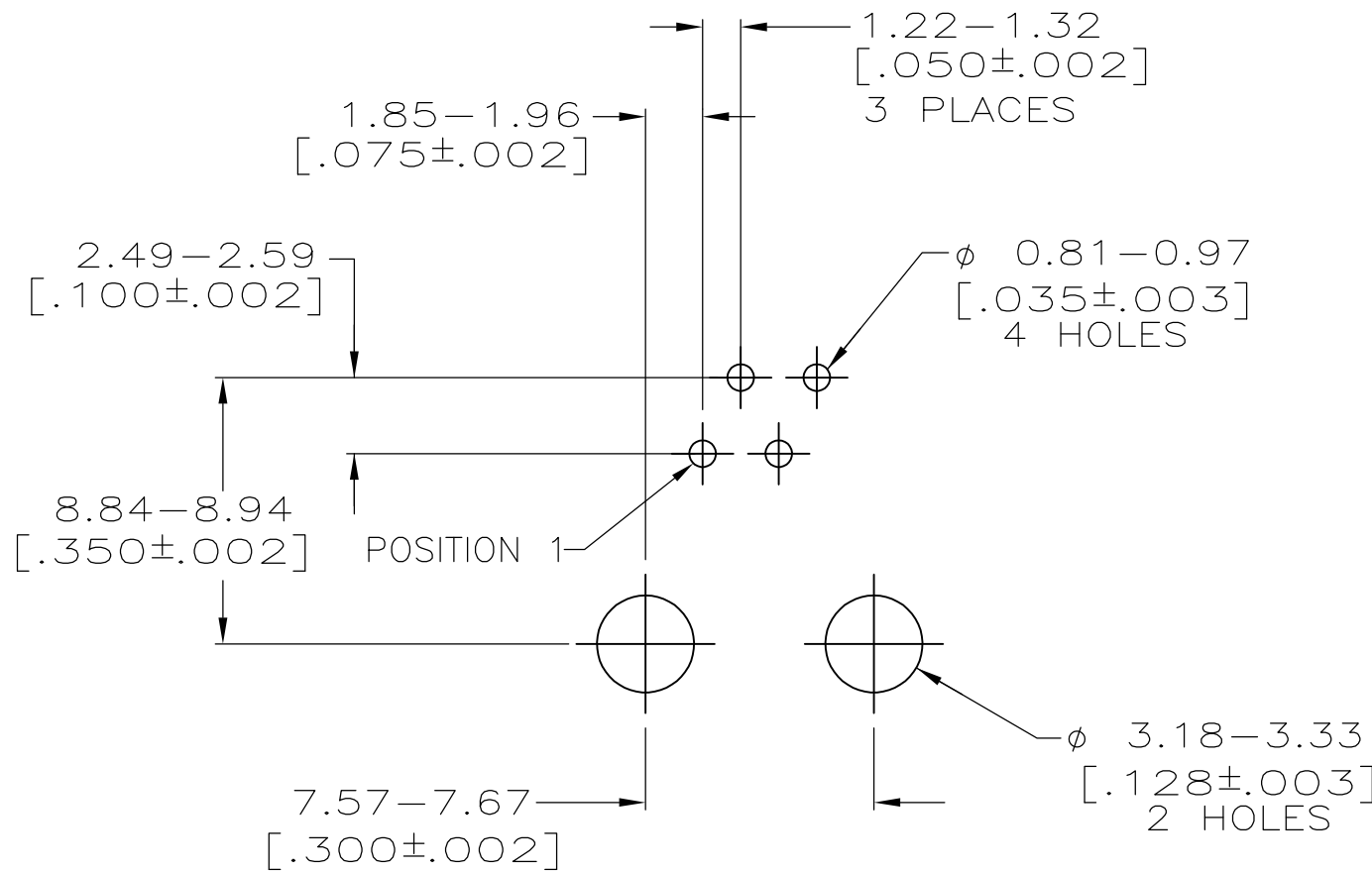
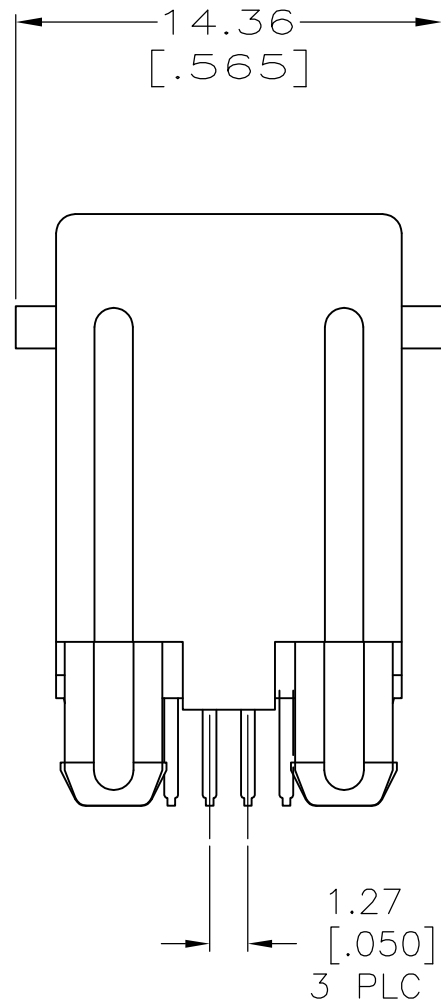
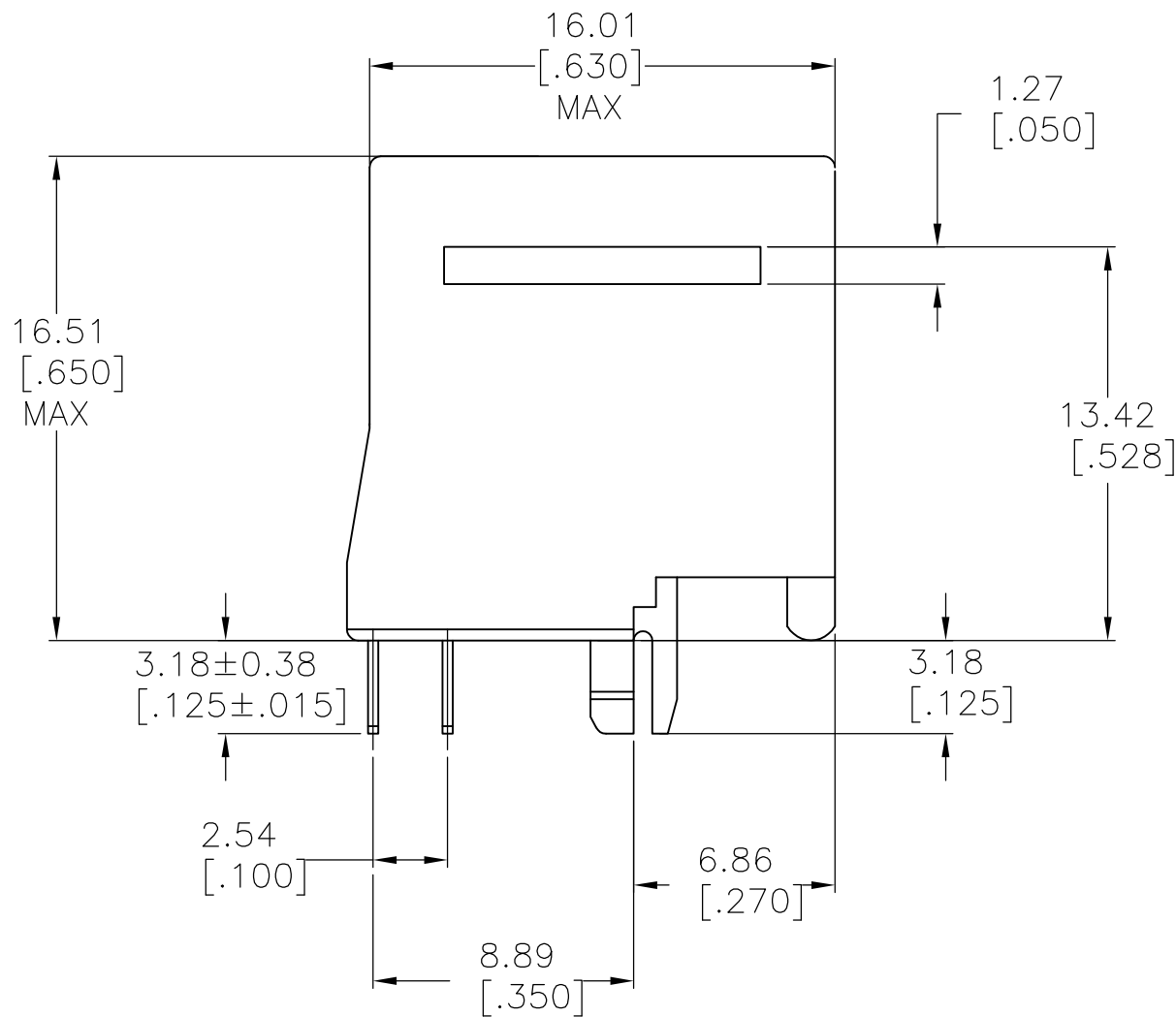


1. MATERIAL: HOUSING — HTN MOLDING COMPOUND, UL 94V-0, COLOR: BLACK
TERMINAL — 0.36[.014] THICK PHOS BRONZE PLATED WITH 1.27μm [.000050] MIN THICK HARD GOLD IN LOCALIZED GOLD PLATE AREA, 3.81μm [.000150] MIN THICK MATTE TIN IN SOLDER AREA AND 1.27μm [.000050] MIN THICK NICKEL UNDERPLATE

2 CAVITY CONFORMS TO FCC RULES AND REGULATIONS PART 68 AND REA BULLETIN 345-81 PE-76 SPECIFICATION FOR MODULAR TELEPHONE HARDWARE.

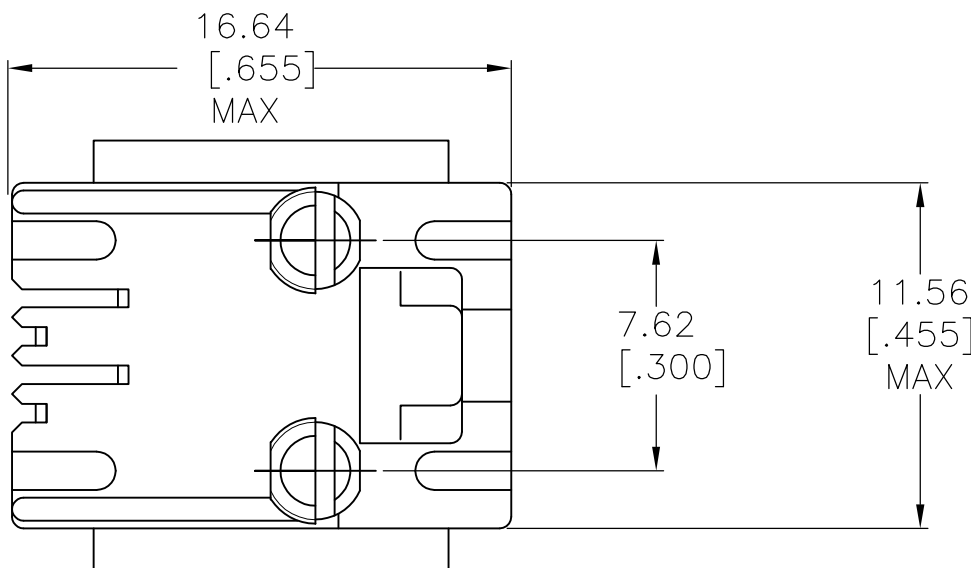
3. BULK PACKAGED IN A TRAY.

C



SUGGESTED PRINTED CIRCUIT BOARD LAYOUT
COMPONENT SIDE

B



A

THIS DRAWING IS A CONTROLLED DOCUMENT.		DWN L.A.MAYER 14AUG2007	Tyco Electronics Corporation Harrisburg, Pa 17105-3608			
DIMENSIONS: mm [INCHES]		CHK P.RECCE 14AUG2007				
		APVD S. FLICKINGER 14AUG2007	NAME MOD JACK ASSEMBLY, TOP ENTRY, 4 POSITION WITH PANEL STOPS			
		PRODUCT SPEC 108-1163 APPLICATION SPEC 114-2048	SIZE A2			
MATERIAL SEE NOTE 1		WEIGHT -	CAGE CODE 00779		DRAWING NO C=5569282	
FINISH SEE NOTE 1		CUSTOMER DRAWING		SCALE 4:1	SHEET 1 OF 1	REV B